## Integrated Audio Amplifier Systems

The Intersil ISL54000, ISL54001, ISL54002 family of devices are integrated audio power amplifier systems that combine stereo BTL $8 \Omega$ amplifiers in a single package. The devices are designed to operate from a single +2.7 V to +5 V power supply. All devices are offered in a 20 Ld $4 \times 4$ thin QFN package. Targeted applications include handheld equipment such as cell-phones, MP3 players, and games/toys.

The ISL54000, ISL54001, ISL54002 parts contain two class AB bridge-tied (BTL) type power amplifiers for driving stereo $8 \Omega$ speakers. Each BTL is capable of delivering 800 mW (typ) with $0.4 \%$ THD +N and 941 mW (typ) with $1 \%$ THD+N of continuous average power into an $8 \Omega$ BTL speaker load when using a 5 V supply.

The ISL54001 and ISL54002 feature a 2:1 stereo input multiplexer front-end. This allows selection between two stereo sources. In addition the ISL54002 has the capability of mixing the stereo inputs.

All devices in this family feature low power shutdown, thermal overload protection and click/pop suppression. The click and pop circuitry eliminates audible transients during audio source changes and transitioning in and out of shutdown.

## Features

- Pb-Free (RoHS Compliant)
- Class AB 941mW Stereo BTL Speaker Amplifiers
- Single Supply Operation +2.7 V to +5.5 V
- THD+N at $1 \mathrm{kHz}, 800 \mathrm{~mW}$ into $8 \Omega$ 0.4\%
- THD +N at $1 \mathrm{kHz}, 941 \mathrm{~mW}$ into $8 \Omega$
- Low Power Shutdown
- Thermal Shutdown Protection
- "Click and Pop" Suppression Circuitry
- 2:1 Stereo Input Mux (ISL54001, ISL54002)
- Mixing of Two Stereo Inputs (ISL54002)
- TTL Logic-Compatible
- Available in 20 Ld $4 \times 4$ Thin QFN


## Applications

- Battery powered, Handheld, and Portable Equipment
- Cellular/mobile Phones
- PDA's, MP3 Players, DVD Players, Cameras
- Laptops, Notebooks, Palmtops
- Handheld Games and Toys
- Desktop Computers


## ISL54002 Typical Application Circuit and Block Diagram



## Pinouts



ISL54001
(20 LD 4X4 TQFN) TOP VIEW


ISL54002
(20 LD 4X4 TQFN)
TOP VIEW


Pin Descriptions

| PIN |  |  | NAME | FUNCTION |
| :---: | :---: | :---: | :---: | :---: |
| ISL54000 | ISL54001 | ISL54002 |  |  |
| 3, 6, 8, 12 | 3, 6, 8, 12 | 3, 6, 8, 12 | $V_{\text {DD }}$ | System Power Supply |
| 4, 9, 20 | 4, 9, 20 | 4, 9, 20 | GND | Ground Connection |
| 11 | - | - | $\mathrm{IN}_{\mathrm{L}}$ | Left Channel Audio Input 1 |
| - | 11 | 11 | $\mathrm{IN}_{1 \mathrm{~L}}$ | Left Channel Audio Input 1 |
| - | 13 | 13 | $1 \mathrm{~N}_{2} \mathrm{~L}$ | Left Channel Audio Input 2 |
| 17 | - | - | $\mathrm{IN}_{\mathrm{R}}$ | Right Channel Audio Input 1 |
| - | 17 | 17 | $1 \mathrm{~N}_{1 \mathrm{R}}$ | Right Channel Audio Input 1 |
| - | 19 | 19 | $1 \mathrm{~N}_{2 R}$ | Right Channel Audio Input 2 |
| 2 | 2 | 2 | OUTL+ | Positive Speaker Output |
| 5 | 5 | 5 | OUTR+ | Positive Speaker Output |
| 1 | 1 | 1 | OUTL- | Negative Speaker Output |
| 7 | 7 | 7 | OUTR- | Negative Speaker Output |
| 14 | 14 | 14 | SD | Shutdown, High to disable amplifiers, Low for normal operation. |
| - | 18 | 18 | INS | Input Select |
| - | - | 16 | MIX | Mixer, High to mix Right and Left Audio Inputs, Low to pass Audio Inputs without mixing |
| 10 | 10 | 10 | REF | Common-mode Bias Voltage, Bypass with a $1 \mu \mathrm{~F}$ capacitor to GND |
| $\begin{gathered} 13,15 \\ 16,18,19 \end{gathered}$ | 15, 16 | 15 | NC | No Connect |

## Ordering Information

| WPART <br> NUMBER | PART <br> MARKING | TEMP. <br> RANGE <br> ( ${ }^{\circ} \mathrm{C}$ ) | PACKAGE <br> (Pb-Free) <br> Tape \& Reel | PKG. <br> DWG. \# |
| :--- | :--- | :--- | :--- | :--- |
| ISL54000IRTZ* <br> (Note) | 540 00IRTZ | -40 to +85 | 20 Ld 4x4 TQFN <br> (Pb-free) | L20.4x4A |
| ISL54001IRTZ* <br> (Note) | 540 01IRTZ | -40 to +85 | 20 Ld 4x4 TQFN <br> (Pb-free) | L20.4x4A |
| ISL54002IRTZ* <br> (Note) | 540 02IRTZ | -40 to +85 | 20 Ld 4x4 TQFN <br> (Pb-free) | L20.4x4A |

*Add "-T" suffix for tape and reel. Please refer to TB347 for details on reel specifications.
NOTE: These Intersil Pb-free plastic packaged products employ special Pb-free material sets; molding compounds/die attach materials and $100 \%$ matte tin plate PLUS ANNEAL - e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb -free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

ISL54000 Truth Table

| SD | OUTR+ | OUTR- | OUTL+ | OUTL- |
| :---: | :---: | :---: | :---: | :---: |
| 1 | Disabled | Disabled | Disabled | Disabled |
| 0 | $\mathrm{IN}_{\mathrm{R}}$ | $\mathrm{IN}_{\mathrm{R}}$ | $\mathrm{IN}_{\mathrm{L}}$ | $\mathrm{IN}_{\mathrm{L}}$ |

## ISL54001 Truth Table

| SD | INS | OUTR+ | OUTR- | OUTL+ | OUTL- |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | X | Disabled | Disabled | Disabled | Disabled |
| 0 | 0 | $\mathrm{IN}_{1 \mathrm{R}}$ | $\mathrm{IN}_{1 \mathrm{R}}$ | $\mathrm{IN}_{1}$ | $\mathrm{IN}_{1 \mathrm{~L}}$ |
| 0 | 1 | $1 \mathrm{~N}_{2 \mathrm{R}}$ | $1 \mathrm{~N}_{2 \mathrm{R}}$ | $1 \mathrm{~N}_{2 \mathrm{~L}}$ | $1 \mathrm{~N}_{2 \mathrm{~L}}$ |

ISL54002 Truth Table

| SD | MIX | INS | OUTR+ | OUTR- | OUTL+ | OUTL- |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | X | X | Disabled | Disabled | Disabled | Disabled |
| 0 | 0 | 0 | $\mathrm{IN}_{1 \mathrm{R}}$ | $1 \mathrm{~N}_{1 \mathrm{R}}$ | $\mathrm{IN}_{1 \mathrm{~L}}$ | $\mathrm{IN}_{1 \mathrm{~L}}$ |
| 0 | 0 | 1 | $1 \mathrm{~N}_{2 \mathrm{R}}$ | $1 \mathrm{~N}_{2 \mathrm{R}}$ | $1 \mathrm{~N}_{2 \mathrm{~L}}$ | $1 \mathrm{~N}_{2 \mathrm{~L}}$ |
| 0 | 1 | X | $\begin{aligned} & \mathrm{IN}_{1 \mathrm{R}}+ \\ & \mathrm{IN}_{2 \mathrm{R}} \end{aligned}$ | $\begin{gathered} \mathrm{IN}_{1 \mathrm{R}}+ \\ \mathrm{IN}_{2 \mathrm{R}} \end{gathered}$ | $\begin{gathered} \mathrm{IN}_{1 \mathrm{~L}}+ \\ \mathrm{IN}_{21}+ \end{gathered}$ | $\begin{aligned} & \mathrm{IN}_{1 \mathrm{~L}}+ \\ & \mathrm{IN}_{2 \mathrm{~L}}+ \end{aligned}$ |


| Absolute Maximum Ratings |  |
| :---: | :---: |
| VDD to GND | -0.3 V to +6.5V |
| Input Voltages |  |
| In_R, In_L, SD, INS, MIX | -0.3V to (VDD +0.3 V ) |
| Output Voltages |  |
| OUT_+, OUT_- | -0.3V to (VDD + 0.3V) |
| Continuous Current (VDD, OUT_, GND) | 750 mA |
| ESD Rating |  |
| Human Body Model | .>2kV |
| Machine Model. | >200V |
| Charged Device Model |  |

## Operating Conditions

Temperature Range $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

## Thermal Information

Thermal Resistance (Typical, Notes 1, 2) $\quad \theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right) \quad \theta_{\mathrm{JC}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ 20 Ld 4x4 TQFN Package . . . . . . . . . 45 6.5
Maximum Junction Temperature . . . . . . . . . . . . . . . . . . . . . . $+150^{\circ} \mathrm{C}$
Maximum Storage Temperature Range . . . . . . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Pb-free reflow profile . . . . . . . . . . . . . . . . . . . . . . . . . . see link below http://www.intersil.com/pbfree/Pb-FreeReflow.asp

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

1. $\theta_{\mathrm{JA}}$ is measured in free air with the component mounted on a high effective thermal conductivity test board with "direct attach" features. $\theta_{\mathrm{JC}}$, the "case temp" is measured at the center of the exposed metal pad on the package underside. See Tech Brief TB379.
2. For $\theta_{\mathrm{JC}}$, the "case temp" location is the center of the exposed metal pad on the package underside.

Electrical Specifications - 5V Supply
Test Conditions: $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{INL}}=0.8 \mathrm{~V}, \mathrm{SD}=\mathrm{MIX}=\mathrm{INS}=\mathrm{V}_{\mathrm{INL}}$, $\mathrm{C}_{\mathrm{REF}}=1 \mu \mathrm{~F}, \mathrm{R}_{\mathrm{L}}$ is terminated between OUT_+ and OUT_- ${ }_{-}$, Unless Otherwise Specified (Note 3).

| PARAMETER | TEST CONDITIONS |  | TEMP <br> ( ${ }^{\circ} \mathrm{C}$ ) | MIN <br> (Notes 4, 5) | TYP | MAX <br> (Notes 4, 5) | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| GENERAL |  |  |  |  |  |  |  |
| Power Supply Range, $\mathrm{V}_{\mathrm{DD}}$ |  |  | Full | 2.7 | - | 5.5 | V |
| Quiescent Supply Current, IDD | INS $=$ MIX $=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}, \mathrm{R}_{\mathrm{L}}=$ None, Inputs $A C$ coupled to ground ( $0.1 \mu \mathrm{~F}$ ) |  | 25 | - | 4.6 | 12 | mA |
|  |  |  | Full | - | 5.5 | - | mA |
| Shutdown Supply Current, ISD | SD $=\mathrm{V}_{\text {INH }}, \mathrm{INS}=\mathrm{MIX}=\mathrm{V}_{\text {INL }}$ or $\mathrm{V}_{\text {INH }}, \mathrm{R}_{\mathrm{L}}=8 \Omega$ ( BTL ), Inputs AC coupled to ground ( $0.1 \mu \mathrm{~F}$ ) |  | 25 | - | 28 | 50 | $\mu \mathrm{A}$ |
|  |  |  | Full | - | 31 | - | $\mu \mathrm{A}$ |
| Input Resistance, $\mathrm{R}_{\mathrm{IN}}$ | INS $=0 \mathrm{~V}$ or $\mathrm{V}_{\text {DD }}$ |  | 25 | - | 100 | - | $k \Omega$ |
| Thermal Shutdown, TSD | $\mathrm{INS}=\mathrm{MIX}=0 \mathrm{~V}$ or $\mathrm{V}_{\text {DD }}$ |  | 25 | - | 150 | - | ${ }^{\circ} \mathrm{C}$ |
| Thermal Shutdown Hysteresis |  |  | 25 | - | 10 | - | ${ }^{\circ} \mathrm{C}$ |
| SD to Full Operation, $\mathrm{T}_{\text {SD(ON) }}$ | $\mathrm{INS}=0 \mathrm{~V}$ or $5 \mathrm{~V}, \mathrm{MIX}=0 \mathrm{~V}$ or 5 V |  | Full | - | 1 | - | ms |
| BTL AMPLIFIER DRIVER |  |  |  |  |  |  |  |
| Output Offset Voltage, $\mathrm{V}_{\text {OS }}$ | Measured OUT_+ and OUT_-, Input AC coupled to ground $(0.1 \mu \mathrm{~F})$ |  | 25 | - | 38 | - | mV |
|  |  |  | Full | - | 49 | - | mV |
| Power Supply Rejection Ratio, PSRR | $\mathrm{V}_{\text {RIPPLE }}=200 \mathrm{~m} \mathrm{~V}_{\mathrm{P}-\mathrm{P},}, \mathrm{R}_{\mathrm{L}}=8 \Omega,$ Input AC coupled to ground ( $0.1 \mu \mathrm{~F}$ ) | $\mathrm{F}_{\text {RIPPLE }}=217 \mathrm{~Hz}$ | 25 | - | 49 | - | dB |
|  |  | $\mathrm{F}_{\text {RIPPLE }}=1 \mathrm{kHz}$ | 25 | - | 47 | - | dB |
| Output Power, POUT | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{THD}+\mathrm{N}=1 \%, \mathrm{f}=1 \mathrm{kHz}$ |  | 25 | - | 941 | - | mW |
|  | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{THD}+\mathrm{N}=10 \%, \mathrm{f}=1 \mathrm{kHz}$ |  | 25 | - | 1.23 | - | W |
| Total Harmonic Distortion + Noise, THD + N | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{P}_{\text {OUT }}=800 \mathrm{~mW}, \mathrm{f}=1 \mathrm{kHz}$ |  | 25 | - | 0.4 | - | \% |
|  | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{P}_{\text {OUT }}=800 \mathrm{~mW}, \mathrm{f}=20 \mathrm{~Hz}$ to 20 kHz |  | 25 | - | 0.7 | - | \% |
| Max Output Voltage Swing, V ${ }_{\text {OUT }}$ | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {SIGNAL }}=5 \mathrm{~V}_{\text {P-P, }} \mathrm{f}=1 \mathrm{kHz}$ |  | 25 | 7.2 | 7.7 | - | $V_{\text {P-P }}$ |
| Signal to Noise Ratio, SNR | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{P}_{\text {OUT }}=900 \mathrm{~mW}, \mathrm{f}=1 \mathrm{kHz}$ |  | 25 | - | 85 | - | dB |
| Output Noise, NOUT | A - Weight filter, BW $=22 \mathrm{~Hz}$ to 22 kHz |  | 25 | - | 125 | - | $\mu \mathrm{V}_{\mathrm{RMS}}$ |

## Electrical Specifications - 5V Supply

Test Conditions: $\mathrm{V}_{\mathrm{DD}}=+5 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=2.4 \mathrm{~V}, \mathrm{~V}_{\mathrm{INL}}=0.8 \mathrm{~V}, \mathrm{SD}=\mathrm{MIX}=\mathrm{INS}=\mathrm{V}_{\mathrm{INL}}$, $C_{\text {REF }}=1 \mu F, R_{L}$ is terminated between OUT_+ and OUT_-, Unless Otherwise Specified (Note 3). (Continued)

| PARAMETER | TEST CONDITIONS | $\begin{aligned} & \text { TEMP } \\ & \left({ }^{\circ} \mathrm{C}\right) \end{aligned}$ | $\begin{gathered} \text { MIN } \\ \text { (Notes 4, 5) } \end{gathered}$ | TYP | $\begin{gathered} \text { MAX } \\ \text { (Notes 4, 5) } \end{gathered}$ | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { Crosstalk } \\ & \mathrm{R}_{\mathrm{CH}} \text { to } \mathrm{L}_{\mathrm{CH}}, \mathrm{~L}_{\mathrm{CH}} \text { to } \mathrm{R}_{\mathrm{CH}} \end{aligned}$ | $R_{L}=8 \Omega$, POUT $=800 \mathrm{~mW}, f=1 \mathrm{kHz}$, Signal coupled from the input of active amplifier to the output of an adjacent amplifier with its input AC coupled to ground. | 25 | - | 80 | - | dB |
| Off-Isolation | SD $=\mathrm{V}_{\text {INH }}, \mathrm{P}_{\text {OUT }}=800 \mathrm{~mW}, \mathrm{f}=10 \mathrm{kHz}$, Signal coupled from input to output of a disabled amplifier. | 25 | - | 130 | - | dB |
| Channel Gain Matching $\mathrm{R}_{\mathrm{CH}}$ to $\mathrm{L}_{\mathrm{CH}}$ | $\mathrm{R}_{\mathrm{L}}=8 \Omega$, VINxR $=\mathrm{VINxL}=3.88 \mathrm{~V}_{\mathrm{P}-\mathrm{P}}$ (Connect to the same source) | 25 | - | +-0.1 | - | dB |
| Channel Phase Matching $\mathrm{R}_{\mathrm{CH}}$ to $\mathrm{L}_{\mathrm{CH}}$ | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{VINxR}=\mathrm{VINxL}=3.88 \mathrm{~V}_{\text {P-P }}$ (Connect to the same source) | 25 | - | 0.01 | - | - |
| LOGIC INPUT |  |  |  |  |  |  |
| Input Leakage Current, ISD, I INS, ${ }^{\prime}$ MIX | $V_{D D}=5 \mathrm{~V}, \mathrm{SD}=0 \mathrm{~V}, \mathrm{INS}=0 \mathrm{~V}, \mathrm{MIX}=0 \mathrm{~V}$ | 25 | -3 | 1.9 | 3 | $\mu \mathrm{A}$ |
|  |  | Full | - | 1.9 | - | $\mu \mathrm{A}$ |
| Input Leakage Current, ISD, ${ }^{\text {I }}$, ${ }^{\prime}$ MIX | $V_{D D}=5 \mathrm{~V}, \mathrm{SD}=\mathrm{V}_{\mathrm{DD}}, \mathrm{INS}=\mathrm{V}_{\mathrm{DD}}, \mathrm{MIX}=\mathrm{V}_{\mathrm{DD}}$ | 25 | -1 | 0.02 | -1 | $\mu \mathrm{A}$ |
|  |  | Full | - | 0.02 | - | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {INH }}$ |  | Full | 2.4 | - | - | V |
| $\mathrm{V}_{\text {INL }}$ |  | Full | - | - | 0.8 | V |

Electrical Specifications - 3.6V Supply Test Conditions: $\mathrm{V}_{\mathrm{DD}}=+3.6 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=1.4 \mathrm{~V} . \mathrm{V}_{\mathrm{INL}}=0.4 \mathrm{~V}, \mathrm{SD}=\mathrm{MIX}=\operatorname{INS}=\mathrm{GSO}=$ $G S 1=V_{\text {INL }}, C_{\text {REF }}=1 \mu \mathrm{~F}$. $\mathrm{R}_{\mathrm{L}}$ is terminated between OUT_+ and OUT_ -, Unless Otherwise Specified (Note 3).

| PARAMETER | TEST CONDITIONS |  | $\begin{aligned} & \text { TEMP } \\ & \left({ }^{\circ} \mathrm{C}\right) \end{aligned}$ | MIN (Notes 4, 5) | TYP | $\begin{gathered} \text { MAX } \\ \text { (Notes 4, 5) } \end{gathered}$ | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| GENERAL |  |  |  |  |  |  |  |
| Quiescent Supply Current, IDD | $\text { INS }=0 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{DD}}, \mathrm{MIX}=0 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{DD}}, \mathrm{R}_{\mathrm{L}}=\text { None, Input }$ AC coupled to ground $(0.1 \mu \mathrm{~F})$ |  | 25 | - | 2.7 | 12 | mA |
|  |  |  | Full | - | 3 | - | mA |
| Shutdown Supply Current, ISD | $\operatorname{INS}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}, \mathrm{MIX}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{DD}}, \mathrm{R}_{\mathrm{L}}=8 \Omega$ (BTL), Input AC coupled to ground ( $0.1 \mu \mathrm{~F}$ ) |  | 25 | - | 13 | 50 | $\mu \mathrm{A}$ |
|  |  |  | Full | - | 15 | - | $\mu \mathrm{A}$ |
| BTL AMPLIFIER DRIVER, $\mathrm{HD}=\mathrm{V}_{\text {INH }}, \mathrm{HO}=\mathrm{V}_{\text {INH, }}$, UNLESS OTHERWISE SPECIFIED |  |  |  |  |  |  |  |
| Output Offset Voltage, $\mathrm{V}_{\text {OS }}$ | Measured between OUT_+ and OUT_-, Input AC coupled to ground ( $0.1 \mu \mathrm{~F}$ ) |  | 25 | - | 25 | - | mV |
|  |  |  | Full | - | 40 | - | mV |
| Power Supply Rejection Ratio, PSRR | $\mathrm{V}_{\text {RIPPLE }}=200 \mathrm{~m} \mathrm{~V}_{\text {P-P, }} \mathrm{R}_{\mathrm{L}}=8 \Omega$, Input AC coupled to ground ( $0.1 \mu \mathrm{~F}$ ) | $\mathrm{F}_{\text {RIPPLE }}=217 \mathrm{~Hz}$ | 25 | - | 49 | - | dB |
|  |  | $\mathrm{F}_{\text {RIPPLE }}=1 \mathrm{kHz}$ | 25 | - | 47 | - | dB |
| Output Power, Pout | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{THD}+\mathrm{N}=1 \%, \mathrm{f}=1 \mathrm{kHz}$ |  | 25 | - | 310 | - | mW |
|  | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{THD}+\mathrm{N}=10 \%, \mathrm{f}=1 \mathrm{kHz}$ |  | 25 | - | 528 | - | mW |
| $\begin{aligned} & \text { Total Harmonic Distortion + Noise, } \\ & \text { THD + N } \end{aligned}$ | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{P}_{\text {OUT }}=200 \mathrm{~mW}, \mathrm{f}=1 \mathrm{kHz}$ |  | 25 | - | 0.4 | - | \% |
|  | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{P}_{\text {OUT }}=200 \mathrm{~mW}, \mathrm{f}=20 \mathrm{~Hz}$ to 20 kHz |  | 25 | - | 0.4 | - | \% |
| Max Output Voltage Swing, V ${ }_{\text {OUT }}$ | $\mathrm{R}_{\mathrm{L}}=8 \Omega, \mathrm{~V}_{\text {SIGNAL }}=3.6 \mathrm{~V}_{\text {P-P, }} \mathrm{f}=1 \mathrm{kHz}$ |  | 25 | - | 5.8 | - | $\mathrm{V}_{\mathrm{P}-\mathrm{P}}$ |
| LOGIC INPUT |  |  |  |  |  |  |  |
| Input Leakage Current, $\mathrm{I}_{\text {SD }}$, $\mathrm{I}_{\text {INS }}$, $\mathrm{I}_{\text {MIX }}$ | $V_{D D}=5 \mathrm{~V}, \mathrm{SD}=0 \mathrm{~V}, \mathrm{INS}=0 \mathrm{~V}, \mathrm{MIX}=0 \mathrm{~V}$ |  | 25 | -3 | 1.9 | 3 | $\mu \mathrm{A}$ |
|  |  |  | Full | - | 1.9 | - | $\mu \mathrm{A}$ |

Electrical Specifications - 3.6V Supply Test Conditions: $\mathrm{V}_{\mathrm{DD}}=+3.6 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{INH}}=1.4 \mathrm{~V} . \mathrm{V}_{\mathrm{INL}}=0.4 \mathrm{~V}, \mathrm{SD}=\mathrm{MIX}=\operatorname{INS}=\mathrm{GSO}=$ $\mathrm{GS1}=\mathrm{V}_{\text {INL }}, \mathrm{C}_{\text {REF }}=1 \mu \mathrm{~F} . \mathrm{R}_{\mathrm{L}}$ is terminated between OUT_+ and OUT_-, Unless Otherwise Specified (Note 3). (Continued)

| PARAMETER | TEST CONDITIONS | TEMP <br> $\left({ }^{\circ} \mathrm{C}\right)$ | MIN <br> (Notes 4,5) | TYP | MAX <br> (Notes 4,5) | UNITS |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |

## NOTES:

3. $\mathrm{V}_{\mathrm{IN}}=$ input voltage to perform proper function.
4. The algebraic convention, whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
5. Parts are $100 \%$ tested at $+25^{\circ} \mathrm{C}$. Over-temperature limits established by characterization and are not production tested.

## ISL54000 Typical Application Circuit and Block Diagram



ISL54001 Typical Application Circuit and Block Diagram


## ISL54002 Typical Application Circuit and Block Diagram



## Detailed Description

The Intersil ISL54000, ISL54001, ISL54002 family of devices are integrated audio power amplifier systems designed to drive $8 \Omega$ speaker loads. They can operate with a supply voltage of +2.7 V to +5 V and provide good quality audio, while requiring minimal external components. Its low $0.4 \%$ THD+N while driving 800 mW into an $8 \Omega$ speaker ensures clean, low distortion amplification of the audio signals. The devices are offered in a 20 Ld $4 \times 4$ TQFN package. Targeted applications include handheld equipment such as cell-phones, MP3 players, and games/toys.

The ISL54000, ISL54001, ISL54002 parts contain two class $A B$ bridge-tied (BTL) type power amplifiers for driving stereo $8 \Omega$ speakers. When powered with a 5 V supply, each BTL is capable of delivering 941 mW (typ) of continuous average power to an $8 \Omega$ speaker load with $1 \%$ THD+N performance. When the speaker load is connected across the positive and negative terminals of the BTL driver, the voltage is doubled across the load and the power is quadrupled.

The ISL54001 and ISL54002 feature a 2:1 stereo input multiplexer front-end. This allows selection between two stereo sources. The INS control pin determines which stereo input is active. Applying a logic " 0 " to the INS control pin selects stereo input $1\left(R_{1}\right.$ and $\left.L_{1}\right)$. Applying a logic " 1 " to the INS control pin selects stereo input $2\left(\mathrm{R}_{2}\right.$ and $\left.\mathrm{L}_{2}\right)$.

The ISL54002 has the capability of mixing the two stereo inputs. When in MIX Mode (MIX = " 1 ") the ISL54002 mixes the $R_{1}$ input with the $R_{2}$ input and sends the combined signal to the OUTR_BTL driver and it mixes the $L_{1}$ input with the $L_{2}$ input and sends the combined signal to the OUTL_BTL driver.
All devices in this family feature low power shutdown, thermal overload protection and click/pop suppression. The click and pop circuitry prohibits switching between input channels until the audio input signals are at their lowest point, which eliminates audible transients in the speakers when changing audio input sources. The click/pop circuitry also keeps speaker transients to an inaudibile level when entering and leaving shutdown.

Typical application circuits and block diagrams for each device in the family are on page 6 and 7 .

## DC Bias Voltage

The ISL54000, ISL54001, ISL54002 have internal DC bias circuitry, which DC offsets the incoming audio signal at $\mathrm{V}_{\mathrm{DD}} / 2$. When using a 5 V supply, the DC offset will be 2.5 V . When using a 3.6 V supply, the DC offset will be 1.8 V .
Since the signal gets biased internally at $\mathrm{V}_{\mathrm{DD}} / 2$, the audio signals need to be AC coupled to the inputs of the device. The value of the AC coupling capacitor depends on the low frequency range required for the application. A capacitor of $0.22 \mu \mathrm{~F}$ will pass a signal as low as 7.2 Hz . The formula
required to calculate the capacitor value is shown in Equation 1:
$C \geq 1 / 6.28 \cdot f \cdot 100 k \Omega$

The 100k $\Omega$ is the impedance looking into the input of the ISL54000, ISL54001, and ISL54002 devices.

## BTL Speaker Amplifiers

The ISL54000, ISL54001, and ISL54002 contain two bridge-tied load (BTL) amplifiers designed to drive a speaker load differentially. The output from one BTL is OUTL+ and OUTL-. The output of the other BTL is OUTR+ and OUTR-.
A single BTL driver consists of inverting and non-inverting power op amps. The AC signal out of each op amp are equal in magnitude but $180^{\circ}$ out-of-phase, so the AC signal at OUTL+ and OUTL- have the same amplitude but are $180^{\circ}$ out-of-phase. The same is true of OUTR+ and OUTR-. The speaker load gets connected between the + terminal and - terminal outputs.

Driving the load differentially using a BTL configuration doubles the output voltage across the speaker load and quadruples the power to the load. In effect you get a gain of two due to this configuration at the load as compared to driving the load with a single-ended amplifier with its load connected between a single amplifier's output and ground.
The outputs of each BTL are biased at $V_{D D} / 2$. When the load gets connected across the + and - terminal of the BTL, the mid supply DC bias voltage at each output gets cancelled out eliminating the need for large bulky output coupling capacitors.

## Low Power Shutdown

With a logic " 1 " at the SD control pin the device enters the low power shutdown state. When in shutdown the output amplifiers go into an high impedance state and supply current is reduced to $26 \mu \mathrm{~A}$ (typ).

In shutdown mode before the amplifiers enter the high impedance/low current drive state, the bias voltage of $\mathrm{V}_{\mathrm{DD}} / 2$ remains connected at the output through a $100 \mathrm{k} \Omega$ resistor. This resistor is not present during active operation of the drivers but gets switched in when the SD pin goes high and disconnected when the SD pin goes low.
Leaving the DC bias voltage connected through this $100 \mathrm{k} \Omega$ resistor reduces the transient that is generated across the speaker, while going into or out of shutdown, to a level that does not produce clicking or popping in the speaker.

## QFN Thermal Pad Considerations

The QFN package features an exposed thermal pad on its underside. This pad lowers the package's thermal resistance by providing a direct heat conduction path from the die to the PCB. Connect the exposed thermal pad to GND by using a
large copper pad and multiple vias to the GND plane. The vias should be plugged and tented with plating and solder mask to ensure good thermal conductivity.

Best thermal performance is achieved with the largest practical copper ground plane area.

## PCB Layout Considersations and Power Supply Bypassing

To maintain the highest load dissipation and widest output voltage swing the power supply PCB traces and the traces that connect the output of the drivers to the speaker loads should be made as wide as possible to minimize losses due to parasitic trace resistance.

Proper supply bypassing is necessary for high power supply rejection and low noise performance. A filter network consisting of a $10 \mu \mathrm{~F}$ capacitor in parallel with a $0.1 \mu \mathrm{~F}$ capacitor is recommended at the voltage regulator that is providing the power to the ISL54000, ISL54001, and ISL54002 IC.

Local bypass capacitors of $0.1 \mu \mathrm{~F}$ should be put at each $\mathrm{V}_{\mathrm{DD}}$ pin of the ISL54000, ISL54001, ISL54002 devices. They should be located as close as possible to the pin, keeping the length of leads and traces as short as possible.

A $1 \mu \mathrm{~F}$ capacitor from the REF pin (pin 10) to GND is needed for optimum PSRR and internal bias voltage stability.

Typical Performance Curves $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified.


FIGURE 1. THD+N vs FREQUENCY


FIGURE 3. THD+N vs OUTPUT POWER


FIGURE 2. THD+N vs FREQUENCY


FIGURE 4. THD+N vs OUTPUT POWER

Typical Performance Curves $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, Unless Otherwise Specified. (Continued)


FIGURE 5. CROSSTALK vs FREQUENCY


FIGURE 7. PSRR vs FREQUENCY


FIGURE 9. POWER DISSIPATION vS OUTPUT POWER


FIGURE 6. OFFISOLATION vs FREQUENCY


FIGURE 8. POWER DISSIPATION vs OUTPUT POWER

## Die Characteristics

SUBSTRATE POTENTIAL (POWERED UP): GND

## PROCESS:

Submicron CMOS

Thin Quad Flat No-Lead Plastic Package (TQFN)
Thin Micro Lead FramePlastic Package (TMLFP)


L20.4x4A
20 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE (COMPLIANT TO JEDEC MO-220WGGD-1 ISSUE I)

| SYMBOL | MILLIMETERS |  |  | NOTES |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | NOMINAL | MAX |  |
| A | 0.70 | 0.75 | 0.80 | - |
| A1 | - | 0.02 | 0.05 | - |
| A2 | - | 0.55 | 0.80 | 9 |
| A3 | 0.20 REF |  |  | 9 |
| b | 0.18 | 0.25 | 0.30 | 5, 8 |
| D | 4.00 BSC |  |  | - |
| D1 | 3.75 BSC |  |  | 9 |
| D2 | 1.95 | 2.10 | 2.25 | 7, 8 |
| E | 4.00 BSC |  |  | - |
| E1 | 3.75 BSC |  |  | 9 |
| E2 | 1.95 | 2.10 | 2.25 | 7, 8 |
| e | 0.50 BSC |  |  | - |
| k | 0.20 | - | - | - |
| L | 0.35 | 0.60 | 0.75 | 8 |
| N | 20 |  |  | 2 |
| Nd | 5 |  |  | 3 |
| Ne | 5 |  |  | 3 |
| P | - | - | 0.60 | 9 |
| $\theta$ | - | - | 12 | 9 |

NOTES:

1. Dimensioning and tolerancing conform to ASME Y14.5-1994.
2. $N$ is the number of terminals.
3. Nd and Ne refer to the number of terminals on each D and E .
4. All dimensions are in millimeters. Angles are in degrees.
5. Dimension $b$ applies to the metallized terminal and is measured between 0.15 mm and 0.30 mm from the terminal tip.
6. The configuration of the pin \#1 identifier is optional, but must be located within the zone indicated. The pin \#1 identifier may be either a mold or mark feature.
7. Dimensions D2 and E2 are for the exposed pads which provide improved electrical and thermal performance.
8. Nominal dimensions are provided to assist with PCB Land Pattern Design efforts, see Intersil Technical Brief TB389.
9. Features and dimensions A2, A3, D1, E1, P \& $\theta$ are present when Anvil singulation method is used and not present for saw singulation.

All Intersil U.S. products are manufactured, assembled and tested utilizing ISO9000 quality systems.
Intersil Corporation's quality certifications can be viewed at www.intersil.com/design/quality

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